IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Glen B. Cook

Patrick Gedeon Jeffrey M. King

Robert Sabia

Serial No:

To Be Assigned

Filed:

Herewith

For:

DIRECT BONDING OF GLASS

ARTICLES FOR DRAWING

Examiner: To Be Assigned

Group Art Unit: To Be Assigned

INFORMATION DISCLOSURE STATEMENT **UNDER 37 C.F.R. §§ 1.56, 1.97 – 1.98**

Asst. Commissioner of Patents and Trademarks Washington, DC 20231

Dear Sir:

The Examiner's attention is hereby directed to the following reference(s) listed on the attached Form PTO-1449 for consideration in connection with the examination of the above-identified patent application. One copy of the reference(s) is enclosed.

This submission does not represent that a search has been made or that no better art exists and does not constitute an admission that each or all of the enclosed documents constitute "prior art." If it should be determined that any of the submitted documents do not constitute "prior art" under United States law, applicant(s) reserve the right to present to the office the relevant facts and law regarding the appropriate status of such documents.

Applicant(s) further reserve the right to take appropriate action to establish the patentability of the disclosed invention over the enclosed references, should one or more of the references be applied against the claims of the present application.

Respectfully submitted,

Timothy M. Schaeberle Registration No. 34,424 Corning Incorporated

SP-TI-03-1

Corning, NY 14831 (607) 974-3164

(Date)

Express Mail Label No. EV041471097US

I hereby certify that this correspondence is being deposited with the

United States Postal Service as express mail in an envelope addressed to Asst. Commissioner of Patents and Trademarks, Washington, D.C. 20231

Revision: March 7, 2000

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FORM PTO-1449 (MODIFIED)

LIST OF PATENTS AND PUBLICATIONS FOR APPLICANTS INFORMATION DISCLOSURE STATEMENT

ATTORNEY DOCKET NO. SP01-302

SERIAL NO.

To Be Assigned

APPLICANT Cook et al.

FILING DATE: Herewith GROUP: To Be Assigned

REFERE	NCE D	ESIGNATION	U.	S. PATENT DOCUMENTS	S			
Examiner Initial		Document Number	Date	Name	Class	Sub- Class	1	g Date oprop.
	AA	5,915,193	6/22/99	Tong et al.	438	455		
	AB	5,785,874	7/28/98	Eda	216	24		
	AC	5,932,048	8/3/99	Furukawa et al.	156	153		
	AD	6,129,854	10/10/00	Ramsey et al.	216	18		
	AE	6,153,495	11/28/00	Kub et al.	438	459		
	AF	6,178,779	1/30/01	Drouart et al.	65	391		
	AG	6,098,429	8/8/01	Mazabraud et al.	65	392		
	AH	4,407,667	10/4/83	LeNoane et al.	65	3.11		
	<u> </u>	F	OREIGN P.	ATENT DOCUMENTS				
		Document Number	Date	Country	Class	Sub- Class	Translation Yes No	
	AI	1 057 793A1	12/6/00	EPO	C03B	37/027	X	
	•	OTHER ART (I	ncluding Au	uthor, Title, Date, Pertinent	Pages, etc	c.)		
	AJ	A. Sayah, D. Solignac, T. Cueni, "Development of novel low temperature bonding technologies for microchip chemical analysis applications," Sensors and Actuators, 84 (2000) pp. 103-108.						

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P. Rangsten, O. Vallin, K. Hermansson, Y. Backlund, "Quartz-to-Quartz Direct bonding," J. Electrochemical Society, V. 146, N. 3, pp. 1104-1105, 1999).

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AM, A. Yamada, et al., Bonding Silicon wafer to Silicon Nitride With Spin-on Glass Adhesive, Electronics Letters, March 26, 1987, Vol. 23, No. 7.

AN D.J. Harrison, et al., Micromachining a Miniaturized Capillary Electrophoresis-Based Chemical Analysis System on a Chip, Science 261 (1993) 895-897.
 AO W.P. Maszara, Silicon-on-insulator by Wafer Bonding: A Review, J. Electrochemical

D-W. Shin, et al., The Stacking Faults and Their Strain Effect at the Si/SiO₂ Interfaces of a Directly Bonded SOI (silicon on insulator), Thin Solid Films, V. 346, pp. 169-173, 1999.

Q-Y. Tong, et al., The Role of Surface Chemistry in Bonding of Standard Silicon Wafers, J. Electrochemical Society V. 144, N. 1, pp. 384-389, 1997

EXAMINER:

AP

AQ

DATE CONSIDERED:

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609: draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.